- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

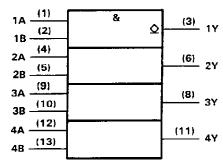
These devices contain four independent 2-input AND gates. The open-collector outputs require pull-up resistors to perform correctly. They may be connected to other open-collector outputs to implement active-low wired-OR or active-high wired-AND functions. Open-collector devices are often used to generate higher VOH levels.

The SN5409, SN54LS09, and SN54S09 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN7409, SN74LS09, and SN74S09 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
Α	В	Y
н	Н	Н
L	Х	L
Х	L	L

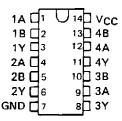
logic symbol



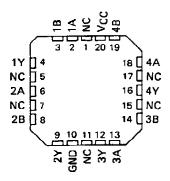
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN5409, SN54LS09, SN54S09... J OR W PACKAGE SN7409... N PACKAGE SN74LS09, SN74S09... D OR N PACKAGE (TOP VIEW)

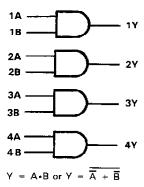


SN54LS09, SN54S09 . . . FK PACKAGE (TOP VIEW)

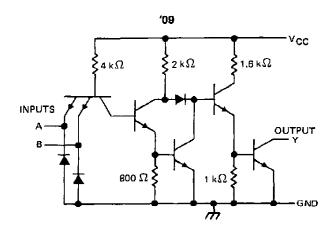


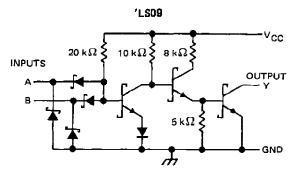
NC-No internal connection

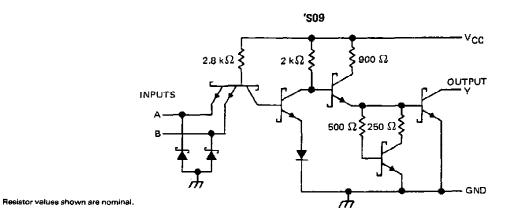
logic diagram (positive logic)



schematics (each gate)







absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)		7 V
Input voltage: '09, 'S09		5.5 V
'LS09	· · · · · · · · · · · · · · · · · · ·	7 V
Operating free-air temperature range:	SN54'	–55°C to 125°C
	SN74'	0°C to 70°C
Storage temperature range		–65°C to 150°C

NOTE 1; Voltage values are with respect to network ground terminal.

SN5409, SN7409 QUADRUPLE 2 INPUT POSITIVE AND GATES WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

	} :	SN5409			SN740	9	UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	UNII
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	٧
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage			0.8			8.0	٧
V _{OH} High-level output voltage			5.5			5.5	٧
IOL Low-level output current			16			16	mΑ
TA Operating free-air temperature	- 55	-	125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN TYP\$ MAX	UNIT
VIK	VCC = MIN,	I _I = - 12 mA	- 1,5	V
(он	V _{CC} - MIN,	V _{1H} = 2 V, V _{OH} = 5,5 V	0.25	mA
VOL	V _{CC} = MIN,	V _{IL} = 0.8 V I _{OL} = 16 mA	0.2 0.4	٧
lj.	VCC = MAX,	V _j = 5.5 V	1	mΑ
Чн	V _{CC} = MAX,	V ₁ = 2.4 V	40	μД
liL.	V _{CC} = MAX,	V ₁ = 0.4 V	- 1.6	mA
ГССН	V _{CC} = MAX,	V ₁ = 4.5 V	11 21	mА
ICCL	V _{CC} = MAX,	V _I = 0 V	20 33	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	түр	MAX	UNIT
^t P L H			0.45.5		21	32	ns
t P HL	A or B	A or B Y R _L = 400	$H_L = 400 \Omega$, $C_L = 15 pF$		16	24	пѕ

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

SN54LS09, SN74LS09 QUADRUPLE 2-INPUT POSITIVE-AND GATES WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

] ;	SN54LS	09		SN74LS	i09	
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage			0.7			8.0	V
VOH High-level output voltage			5.5			5.5	٧
IOL Low-level output current			4			8	mΑ
Тд Operating free-air temperature	- 55		125	0	•	70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

******		TEST COND	TIONS +		SN54LS	09	SN74LS09			UNIT
PARAMETER		TEST CONDI	110145 [MIN	TYP‡	MAX	MIN	TYP\$	MAX	UNII
VIK	V _{CC} = MIN,	lı = — 18 mA				- 1.5			- 1.5	V
юн	V _{CC} = MIN,	V _{IH} = 2 V,	V _{OH} = 5.5 V			0.1			0.1	mΑ
	V _{CC} = MIN,	V _{IL} = MAX,	IOL = 4 mA		0.25	0.4		0.25	0.4	v
VOL	VCC = MIN,	VIL = MAX,	I _{OL} = 8 mA				· · · · · · · · · · · · · · · · · · ·	0.35	0.5	1
11	V _{CC} = MAX,	V _I = 7 V				0.1			0.1	mA
ЧН	V _{CC} = MAX,	V ₁ = 2.7 V				20			20	μΑ
IIL.	V _{CC} = MAX,	V ₁ = 0.4 V	· · · · · · · · · · · · · · · · · · ·			- 0.4	***		- 0.4	mA
Іссн	V _{CC} = MAX,	V ₁ = 4.5 V			2.4	4.8		2.4	4.8	mA
CCL	V _{CC} = MAX,	V = 0 V			4,4	8.8		4.4	8.8	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO {QUTPUT}	TEST CON	NDITIONS	MIN	TYP	MAX	UNIT
t _{PLH}	A or B	v	$R_1 = 2 k\Omega$,	C _f = 15 pF		20	35	ns
₹PHL	7, 5, 5	,	11[- 2 838,	of - 19 be		17	35	กร

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

[‡] All typical values are at V_{CC} = 5 V, T_{A} = 25°C.

SN54S09, SN74S09 QUADRUPLE 2-INPUT POSITIVE-AND GATES WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

		SN54S0	9		SN7450	19	
	MIN	NOM	MAX	MIN	NOM	MAX	TINU
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{1H} High-level input voltage	2			2			٧
V _{IL} Low-level input voltage			0.8			0.8	v
VOH High-level output voltage			5.5	_		5.5	٧
IOL Low-level output current			20			20	mA
TA Operating free-air temperature	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	MIN TYP# MAX	TINU
ViK	V _{CC} = MIN,	i ₁ = - 18 mA	-1.2	V
ГОН	VCC = MIN,	V _{IH} = 2 V, V _{OH} = 5.5 V	0.25	mA
Vol	V _{CC} = MIN,	V _{IL} = 0.8 V, I _{OL} = 20 mA	0.5	V
lj.	V _{CC} = MAX,	V ₁ = 5.5 V	1	mA
¹ ін	V _{CC} = MAX,	V _I = 2,7 V	50	μА
li L	V _{CC} = MAX,	V _I = 0.5 V	-2	mA
1 _{ССН}	V _{CC} = MAX,	V ₁ = 4.5 V	18 32	mA
ICCL	V _{CC} = MAX,	V _I = 0 V	32 57	mΑ

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	TEST CONDITIONS			UNIT
[‡] PLH			R _L = 280 Ω,	C _I = 15 pF	6.5	10	ns
tPHL.	A or B			C[- 19pr	6.5	10	ns
tPLH	AUrb	[D - 200 C	0 .50 .5	9		ns
^t PHL			R _L = 280 Ω,	C _L = 50 pF	9		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



www.ti.com 11-May-2023

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
80019012A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	80019012A SNJ54LS 09FK	Samples
8001901CA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8001901CA SNJ54LS09J	Samples
8001901CA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8001901CA SNJ54LS09J	Samples
8001901DA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8001901DA SNJ54LS09W	Samples
8001901DA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8001901DA SNJ54LS09W	Samples
SN54LS09J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS09J	Samples
SN54LS09J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS09J	Samples
SN54S09J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S09J	Samples
SN54S09J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S09J	Samples
SN74LS09DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS09	Samples
SN74LS09DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS09	Samples
SN74LS09DRE4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS09	Samples
SN74LS09DRE4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS09	Samples
SN74LS09N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS09N	Samples
SN74LS09N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS09N	Samples
SN74LS09NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS09	Samples
SN74LS09NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS09	Samples
SN74S09N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S09N	Samples



www.ti.com 11-May-2023

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74S09N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S09N	Samples
SN74S09NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74\$09	Samples
SN74S09NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74S09	Samples
SNJ54LS09FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	80019012A SNJ54LS 09FK	Samples
SNJ54LS09FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	80019012A SNJ54LS 09FK	Samples
SNJ54LS09J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8001901CA SNJ54LS09J	Samples
SNJ54LS09J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8001901CA SNJ54LS09J	Samples
SNJ54LS09W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8001901DA SNJ54LS09W	Samples
SNJ54LS09W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8001901DA SNJ54LS09W	Samples
SNJ54S09J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S09J	Samples
SNJ54S09J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S09J	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet J\$709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

PACKAGE OPTION ADDENDUM

www.ti.com 11-May-2023

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54LS09, SN54S09, SN74LS09, SN74S09:

Catalog: SN74LS09, SN74S09

Military: SN54LS09, SN54S09

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

www.ti.com 12-May-2023

TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS09DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS09NSR	so	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74S09NSR	so	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



www.ti.com 12-May-2023



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins SPQ		Length (mm)	Width (mm)	Height (mm)	
SN74LS09DR	SOIC	D	14	2500	356.0	356.0	35.0	
SN74LS09NSR	SO	NS	14	2000	356.0	356.0	35.0	
SN74S09NSR	SO	NS	14	2000	356.0	356.0	35.0	

PACKAGE MATERIALS INFORMATION

www.ti.com 12-May-2023

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
80019012A	FK	LCCC	20	1	506.98	12.06	2030	NA
8001901DA	W	CFP	14	1	506.98	26.16	6220	NA
SN74LS09N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS09N	N	PDIP	14	25	506	13.97	11230	4.32
SN74S09N	N	PDIP	14	25	506	13.97	11230	4.32
SN74S09N	N	PDIP	14	25	506	13.97	11230	4.32
SNJ54LS09FK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ54LS09W	W	CFP	14	1	506.98	26.16	6220	NA

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
 Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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